UCC28630 REFERENCE DESIGN

Product Title:

Public Release

PCB Number: PMP9208

PCB Rev: E2

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Not in version control

SVN Rev: PMP9208

Number: E2

PCB Label:

Remarks:

This Assembly Note is for PCB labels only

Assembly Note:

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note:

These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

PCB Label:

Texas Instruments

OUTPUT PLUG

3M - 1350F-1 25MM - TAPE, POLYESTER, 25MMX66M, 2.5MIL THICK

130FT 1 25MM

PIHS101

PIHS102

COH10 COH11 COH12

COH13 COH14 COH15

PIHS201

PIHS202

COHS1

COHS2

COH9

2 2

25/03/2014

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